



Inductors for Power Circuits

Winding metal magnetic material

VLS-HBX-1 series

VLS201610HBX-1

VLS201612HBX-1

VLS252010HBX-1

VLS252012HBX-1

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Inductors for Power Circuits

Wound Ferrite

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of the VLS-HBX-1 Series

FEATURES

- Magnetic shield type wound inductor for power circuits using a metallic magnetic material.
- High magnetic shield construction and compatible with high-density mounting.
- Larger current was achieved by the metallic magnetic material.

APPLICATION

Smart phones, tablet terminals, HDDs, SSDs, DVCs, DSCs, mobile display panels, portable game devices, compact power supply modules, other

PART NUMBER CONSTRUCTION

VLS	201610	HB	X	-	R24	M	-	1
Series name	LxWxH Dimensions (mm)		internal code 1	internal code 2	Inductance (μH)		Inductance tolerance	Marking
	201610	2.0×1.6×1.0			R24	0.24	M	±20%
	201612	2.0×1.6×1.2			2R2	2.2		
	252010	2.5×2.0×1.0			100	10		
	252012	2.5×2.0×1.2						

OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

Type	Temperature range		Package quantity (pieces/reel)	Individual weight (mg)
	Operating temperature*	Storage temperature**		
	(°C)	(°C)		
VLS201610HBX-1	-40 to +105	-40 to +105	2000	16
VLS201612HBX-1	-40 to +105	-40 to +105	2000	20
VLS252010HBX-1	-40 to +105	-40 to +105	2000	26
VLS252012HBX-1	-40 to +105	-40 to +105	2000	30

* Operating temperature range includes self-temperature rise.

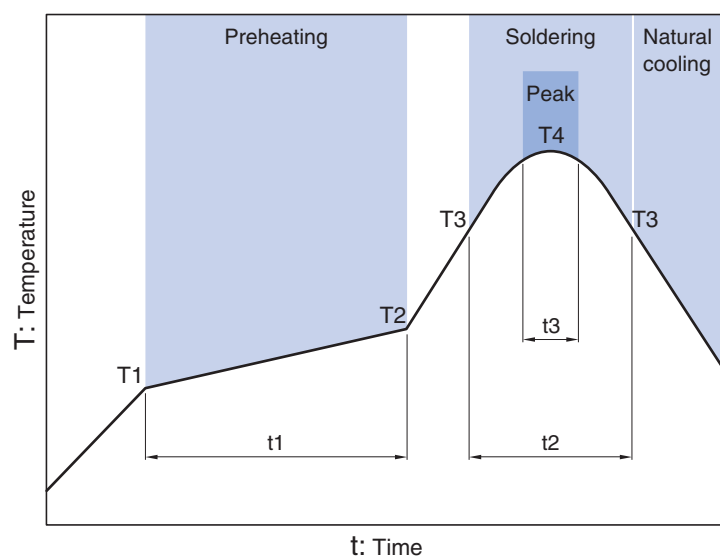
** The Storage temperature range is for after the circuit board is mounted.

- RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. <http://product.tdk.com/en/environment/rohs/>
- Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

• All specifications are subject to change without notice.

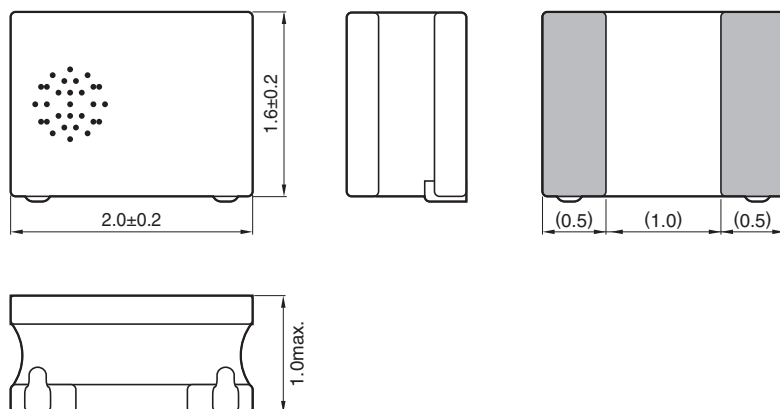
Overview of the VLS-HBX-1 Series

RECOMMENDED REFLOW PROFILE

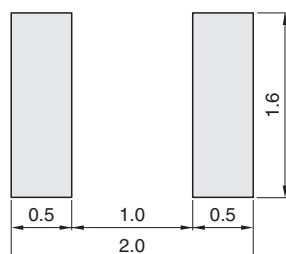


Preheating			Soldering		Peak	
Temp.	Temp.	Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30s	260°C	10s

VLS-HBX-1 series

VLS201610HBX-1 Type**■ SHAPE & DIMENSIONS**

Dimensions in mm

■ RECOMMENDED LAND PATTERN

Dimensions in mm

VLS-HBX-1 series VLS201610HBX-1 Type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

L (μH)	Tolerance	L measuring frequency (MHz)	DC resistance (Ω)		Rated current*(A)				Part No.
			max.	typ.	max.	typ.	max.	typ.	
0.24	±20%	1	0.030	0.023	4.81	3.74	5.15	4.40	VLS201610HBX-R24M-1
0.33	±20%	1	0.039	0.031	4.42	2.85	4.79	3.35	VLS201610HBX-R33M-1
0.47	±20%	1	0.041	0.034	3.50	2.81	4.00	3.30	VLS201610HBX-R47M-1
0.68	±20%	1	0.053	0.044	3.10	2.47	3.53	2.90	VLS201610HBX-R68M-1
1.0	±20%	1	0.072	0.060	2.50	2.13	2.90	2.50	VLS201610HBX-1R0M-1
1.5	±20%	1	0.116	0.097	2.00	1.63	2.20	1.92	VLS201610HBX-1R5M-1
2.2	±20%	1	0.170	0.142	1.70	1.45	1.90	1.70	VLS201610HBX-2R2M-1
3.3	±20%	1	0.252	0.210	1.20	1.02	1.35	1.20	VLS201610HBX-3R3M-1
4.7	±20%	1	0.370	0.308	1.10	0.81	1.20	0.95	VLS201610HBX-4R7M-1
6.8	±20%	1	0.558	0.465	0.88	0.70	0.98	0.82	VLS201610HBX-6R8M-1
10	±20%	1	0.768	0.640	0.65	0.61	0.75	0.72	VLS201610HBX-100M-1

* Rated current: smaller value of either Idc1 or Idc2.

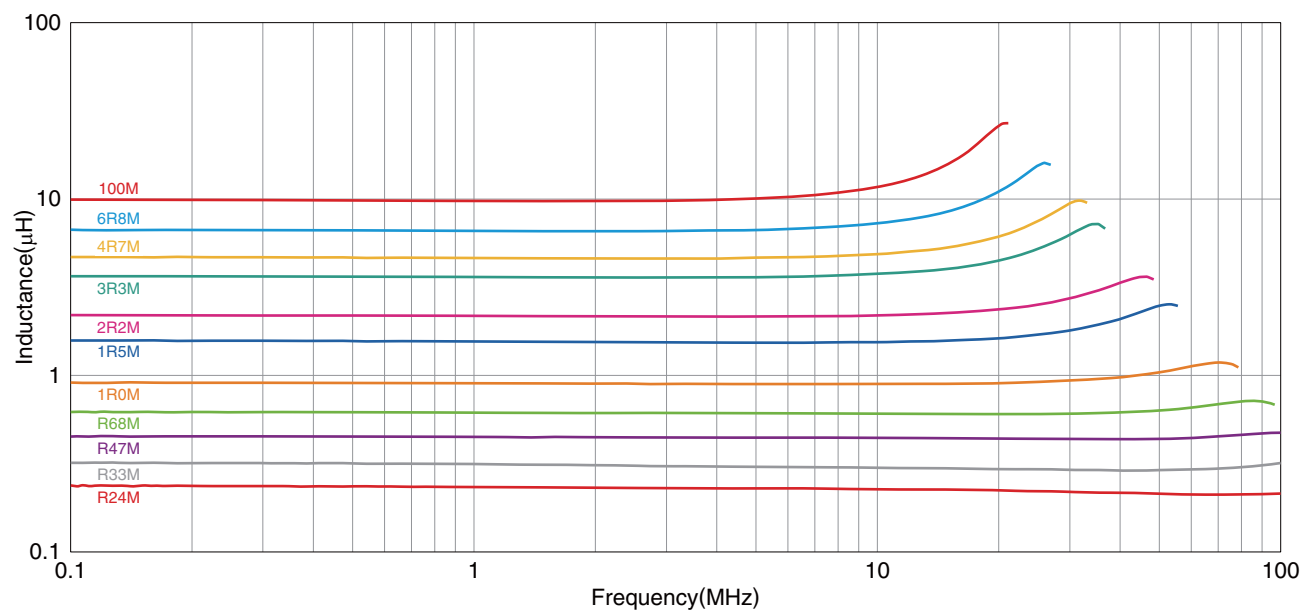
Idc1: When based on the inductance change rate (30% below the nominal L value)

Idc2: When based on the temperature increase (Temperature increase of 40°C by self heating)

Measurement equipment

Measurement item	Product No.	Manufacturer
L	4194A	Agilent Technologies
DC resistance	VP-2941A	Panasonic
Rated current Idc1	4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS201610HBX-1 Type****ELECTRICAL CHARACTERISTICS****L FREQUENCY CHARACTERISTICS GRAPH**

○ Measurement equipment

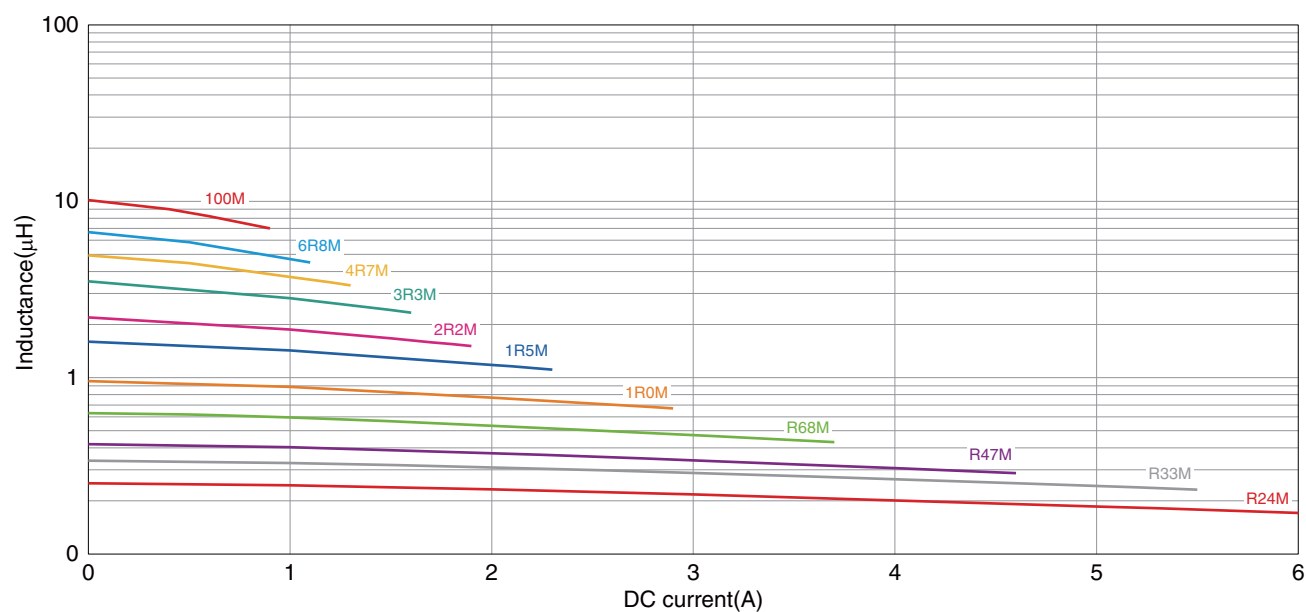
Product No.	Manufacturer
4294A	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS201610HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH

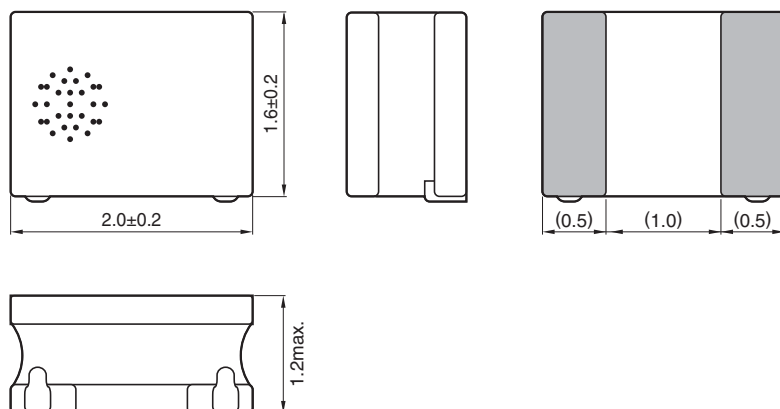


○ Measurement equipment

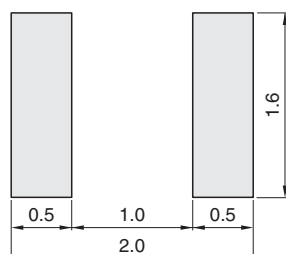
Product No.	Manufacturer
4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series

VLS201612HBX-1 Type**■ SHAPE & DIMENSIONS**

Dimensions in mm

■ RECOMMENDED LAND PATTERN

Dimensions in mm

VLS-HBX-1 series **VLS201612HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ CHARACTERISTICS SPECIFICATION TABLE

L (μH)	Tolerance	L measuring frequency (MHz)	DC resistance (Ω)		Rated current*(A)				Part No.
			max.	typ.	max.	Idc2	typ.	Idc2	
0.24	±20%	1	0.029	0.022	5.65	4.25	6.50	5.00	VLS201612HBX-R24M-1
0.33	±20%	1	0.035	0.028	4.34	3.87	5.00	4.55	VLS201612HBX-R33M-1
0.47	±20%	1	0.042	0.035	3.78	3.20	4.35	3.76	VLS201612HBX-R47M-1
0.68	±20%	1	0.054	0.045	3.03	2.77	3.50	3.26	VLS201612HBX-R68M-1
1.0	±20%	1	0.071	0.059	2.70	2.42	3.10	2.85	VLS201612HBX-1R0M-1
1.5	±20%	1	0.109	0.091	2.16	1.89	2.50	2.22	VLS201612HBX-1R5M-1
2.2	±20%	1	0.137	0.114	1.85	1.67	2.10	1.97	VLS201612HBX-2R2M-1
3.3	±20%	1	0.209	0.174	1.38	1.33	1.60	1.57	VLS201612HBX-3R3M-1
4.7	±20%	1	0.312	0.260	1.20	1.10	1.37	1.29	VLS201612HBX-4R7M-1
6.8	±20%	1	0.468	0.390	0.91	0.87	1.07	1.02	VLS201612HBX-6R8M-1
10	±20%	1	0.756	0.630	0.76	0.67	0.89	0.79	VLS201612HBX-100M-1

* Rated current: smaller value of either Idc1 or Idc2.

Idc1: When based on the inductance change rate (30% below the nominal L value)

Idc2: When based on the temperature increase (Temperature increase of 40°C by self heating)

○ Measurement equipment

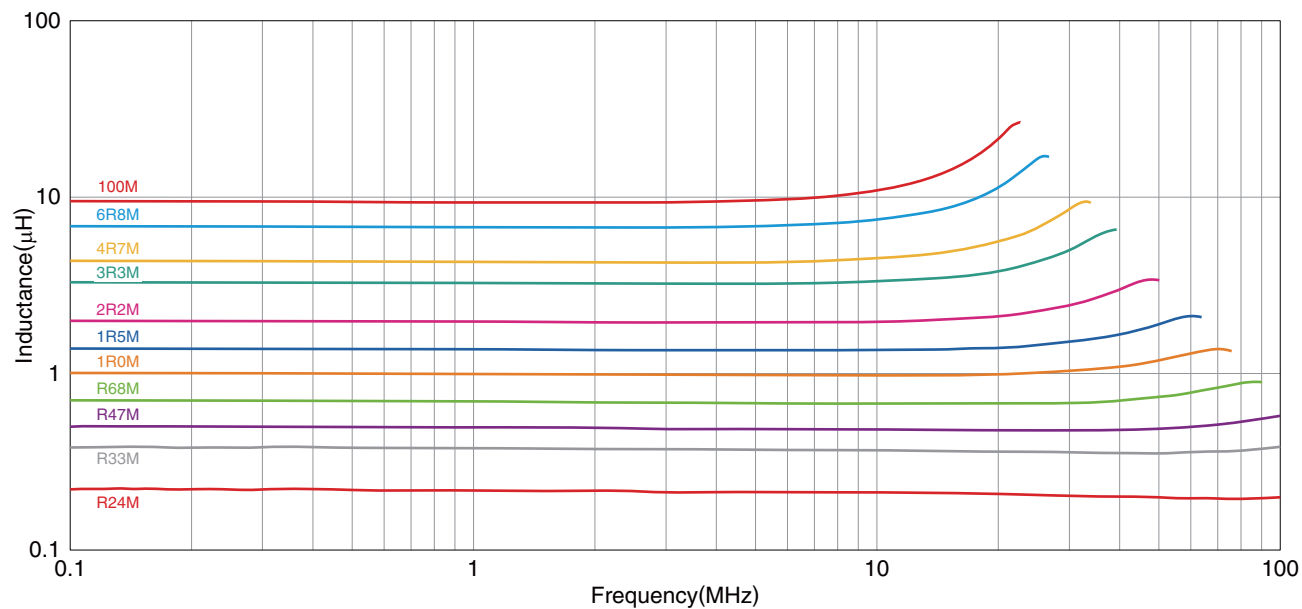
Measurement item	Product No.	Manufacturer
L	4194A	Agilent Technologies
DC resistance	VP-2941A	Panasonic
Rated current Idc1	4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS201612HBX-1 Type**

ELECTRICAL CHARACTERISTICS

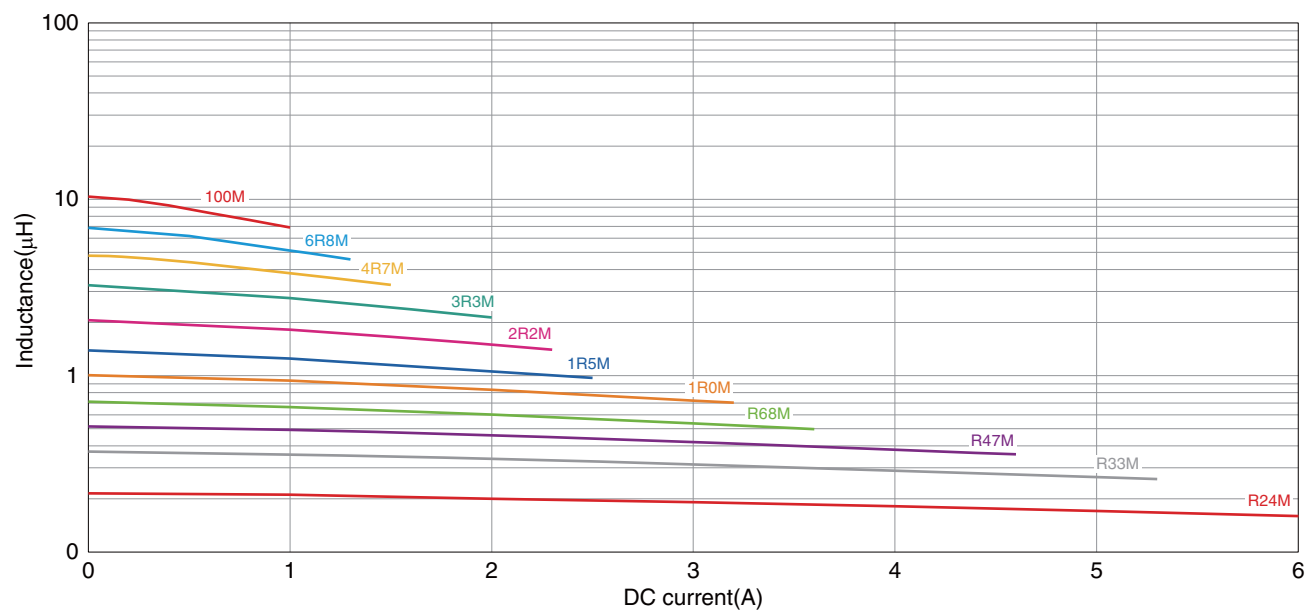
L FREQUENCY CHARACTERISTICS GRAPH



VLS-HBX-1 series **VLS201612HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH

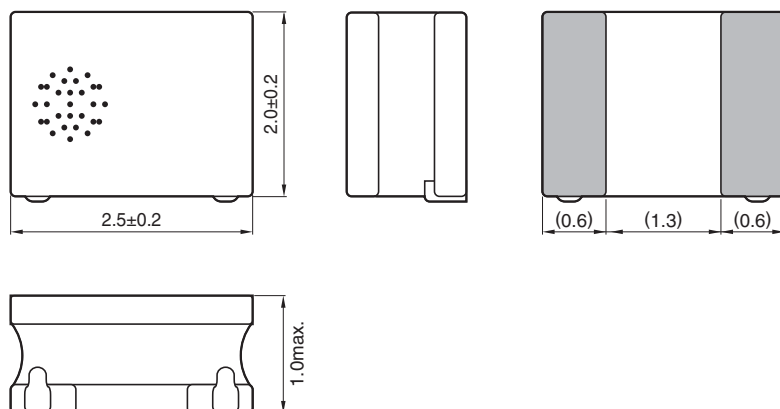


○ Measurement equipment

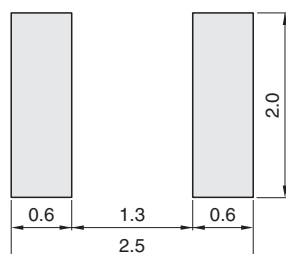
Product No.	Manufacturer
4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series

VLS252010HBX-1 Type**■ SHAPE & DIMENSIONS**

Dimensions in mm

■ RECOMMENDED LAND PATTERN

Dimensions in mm

VLS-HBX-1 series **VLS252010HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ CHARACTERISTICS SPECIFICATION TABLE

L (μH)	Tolerance	L measuring frequency (MHz)	DC resistance (Ω)		Rated current*(A)				Part No.
			max.	typ.	max.	Idc2	typ.	Idc2	
0.24	±20%	1	0.029	0.022	6.55	3.91	7.10	4.60	VLS252010HBX-R24M-1
0.33	±20%	1	0.031	0.025	5.03	3.74	5.46	4.40	VLS252010HBX-R33M-1
0.47	±20%	1	0.035	0.029	4.53	3.32	5.25	3.90	VLS252010HBX-R47M-1
0.68	±20%	1	0.048	0.040	3.62	2.98	4.17	3.50	VLS252010HBX-R68M-1
1.0	±20%	1	0.065	0.054	3.22	2.55	3.57	3.00	VLS252010HBX-1R0M-1
1.5	±20%	1	0.094	0.078	2.70	2.02	3.00	2.38	VLS252010HBX-1R5M-1
2.2	±20%	1	0.120	0.100	2.30	1.76	2.60	2.07	VLS252010HBX-2R2M-1
3.3	±20%	1	0.178	0.148	1.60	1.26	1.90	1.48	VLS252010HBX-3R3M-1
4.7	±20%	1	0.250	0.208	1.40	1.09	1.60	1.28	VLS252010HBX-4R7M-1
6.8	±20%	1	0.406	0.338	1.10	0.75	1.25	0.88	VLS252010HBX-6R8M-1
10	±20%	1	0.552	0.460	0.95	0.68	1.13	0.80	VLS252010HBX-100M-1

* Rated current: smaller value of either Idc1 or Idc2.

Idc1: When based on the inductance change rate (30% below the nominal L value)

Idc2: When based on the temperature increase (Temperature increase of 40°C by self heating)

○ Measurement equipment

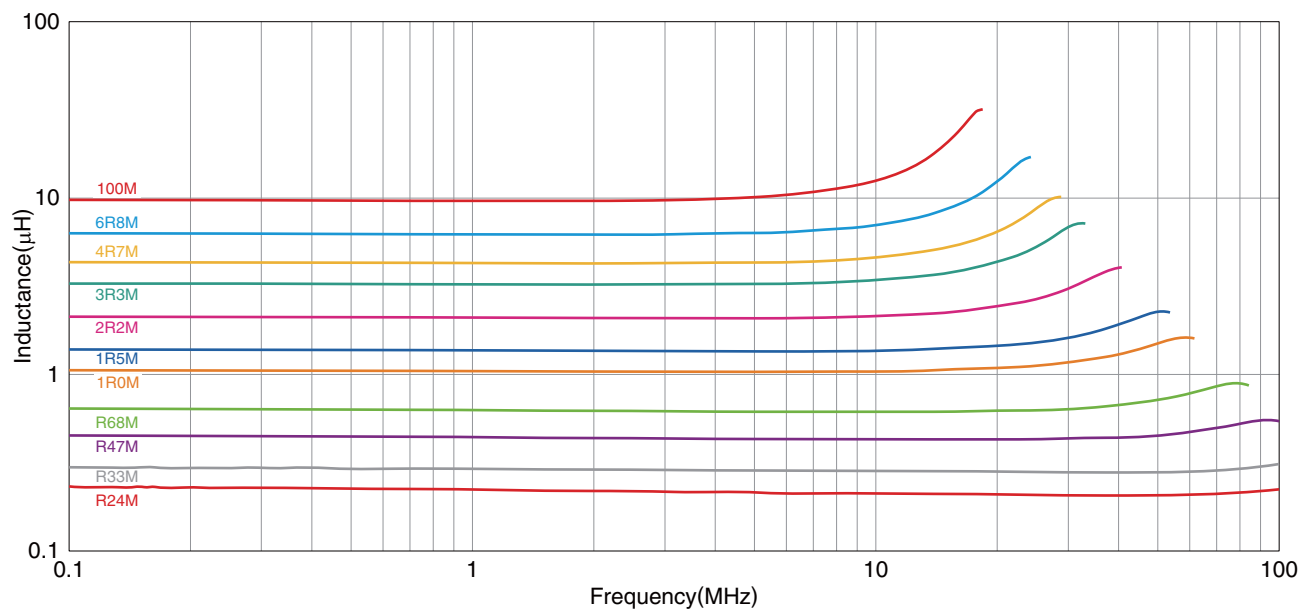
Measurement item	Product No.	Manufacturer
L	4194A	Agilent Technologies
DC resistance	VP-2941A	Panasonic
Rated current Idc1	4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS252010HBX-1 Type**

ELECTRICAL CHARACTERISTICS

L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

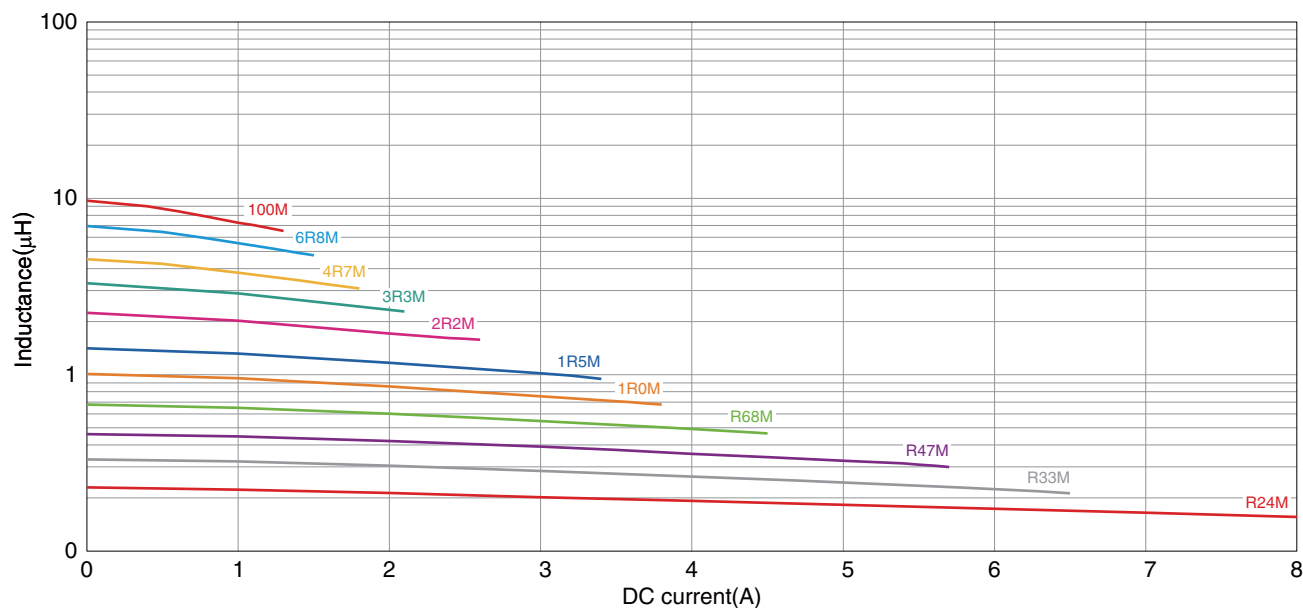
Product No.	Manufacturer
4294A	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS252010HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH

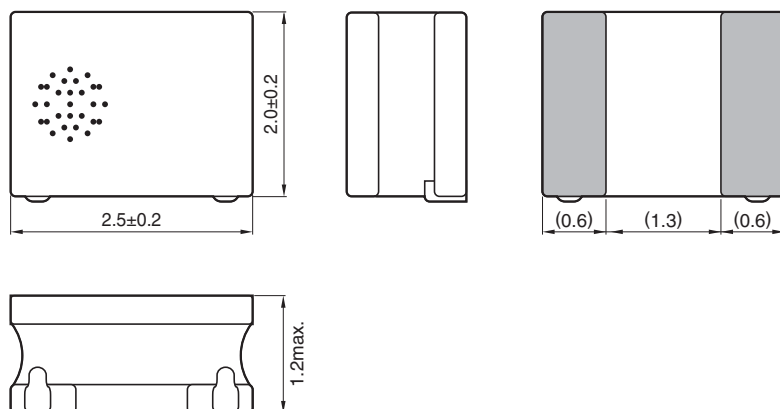


○ Measurement equipment

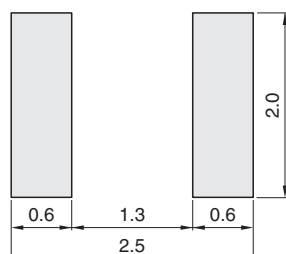
Product No.	Manufacturer
4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series

VLS252012HBX-1 Type**■ SHAPE & DIMENSIONS**

Dimensions in mm

■ RECOMMENDED LAND PATTERN

Dimensions in mm

VLS-HBX-1 series **VLS252012HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ CHARACTERISTICS SPECIFICATION TABLE

L (μH)	Tolerance	L measuring frequency (MHz)	DC resistance (Ω)		Rated current*(A)				Part No.
			max.	typ.	max. Idc1	typ. Idc2	max. Idc1	typ. Idc2	
0.24	±20%	1	0.029	0.022	6.40	4.25	7.10	5.00	VLS252012HBX-R24M-1
0.33	±20%	1	0.031	0.025	5.25	4.04	5.80	4.75	VLS252012HBX-R33M-1
0.47	±20%	1	0.035	0.029	4.50	4.00	5.20	4.70	VLS252012HBX-R47M-1
0.68	±20%	1	0.046	0.038	3.70	3.23	4.25	3.80	VLS252012HBX-R68M-1
1.0	±20%	1	0.056	0.047	3.40	3.00	4.00	3.53	VLS252012HBX-1R0M-1
1.5	±20%	1	0.082	0.068	2.75	2.50	3.10	2.94	VLS252012HBX-1R5M-1
2.2	±20%	1	0.102	0.085	2.30	2.04	2.75	2.40	VLS252012HBX-2R2M-1
3.3	±20%	1	0.168	0.140	1.80	1.55	2.10	1.82	VLS252012HBX-3R3M-1
4.7	±20%	1	0.240	0.200	1.55	1.40	1.90	1.65	VLS252012HBX-4R7M-1
6.8	±20%	1	0.372	0.310	1.15	0.94	1.35	1.10	VLS252012HBX-6R8M-1
10	±20%	1	0.540	0.450	1.00	0.85	1.30	1.00	VLS252012HBX-100M-1

* Rated current: smaller value of either Idc1 or Idc2.

Idc1: When based on the inductance change rate (30% below the nominal L value)

Idc2: When based on the temperature increase (Temperature increase of 40°C by self heating)

○ Measurement equipment

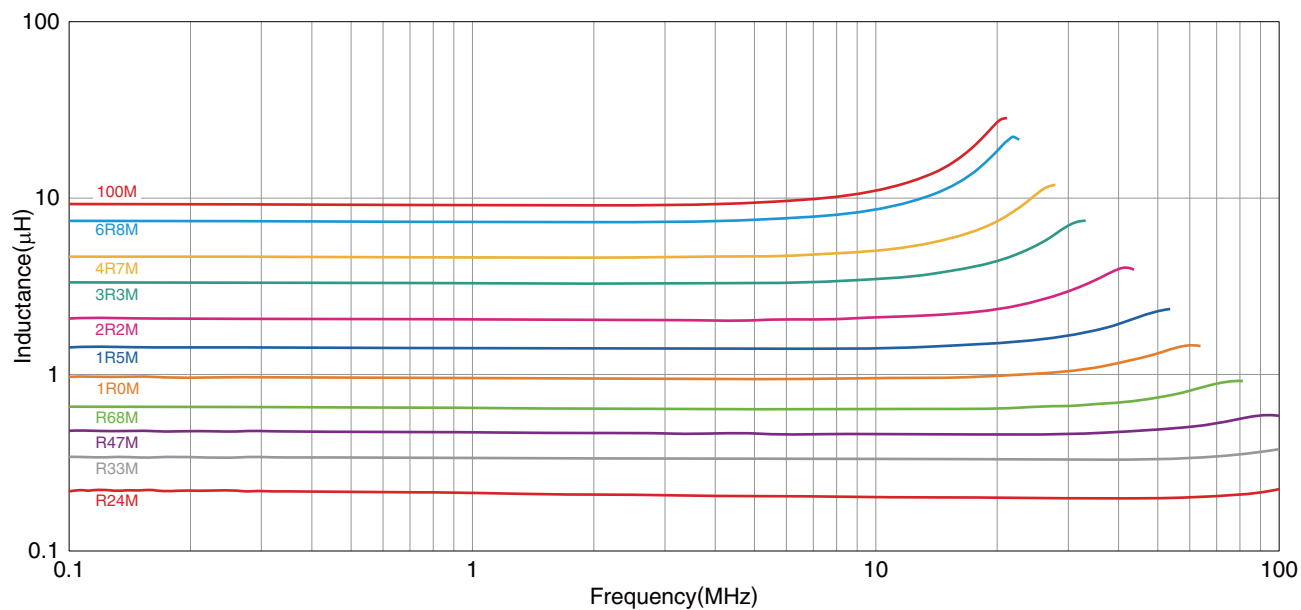
Measurement item	Product No.	Manufacturer
L	4194A	Agilent Technologies
DC resistance	VP-2941A	Panasonic
Rated current Idc1	4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series VLS252012HBX-1 Type

ELECTRICAL CHARACTERISTICS

L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

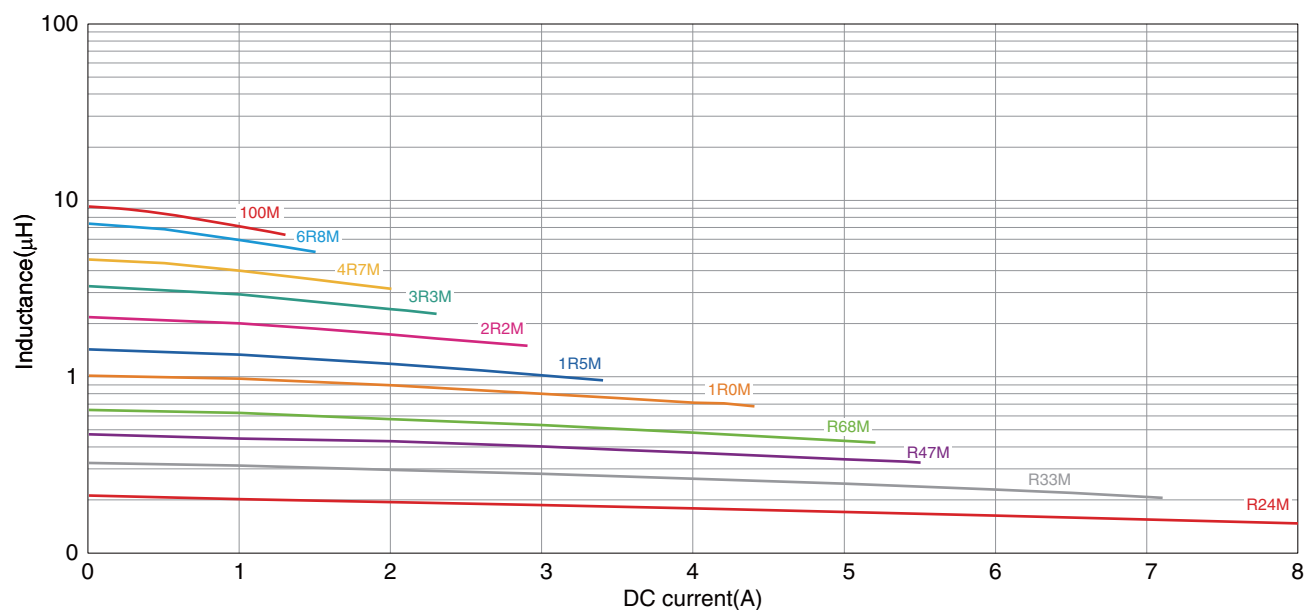
Product No.	Manufacturer
4294A	Agilent Technologies

* Equivalent measurement equipment may be used.

VLS-HBX-1 series **VLS252012HBX-1 Type**

■ ELECTRICAL CHARACTERISTICS

□ INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4285A+42841A+42842C	Agilent Technologies

* Equivalent measurement equipment may be used.

Packaging Style

Technical drawing of a circular component with a central hole and a vertical slot. The drawing includes a top view and a side view.

Top View Dimensions:

- Central hole diameter: $\phi 13.0 \pm 0.5$
- Outer hole diameter: $\phi 21.0 \pm 0.8$
- Slot width: 2.0 ± 0.5
- Overall width: A
- Note (1.0) points to the central hole.

Side View Dimensions:

- Slot depth: Z
- Slot width: E
- Slot width at base: W1
- Slot width at base: W2

Dimensions in mm

* These values are typical values.

Technical drawing of a 10-hole punch plate. The drawing includes three views: a top view, a side view, and a cross-sectional view. The top view shows a rectangular plate with 10 circular holes arranged in a single row. The holes are labeled with dimensions: $\phi D0$ for the hole diameter, $P2$ for the pitch between the first two holes, $P0$ for the distance from the edge to the first hole, $P1$ for the distance between the fourth and sixth holes, E for the total length, F for the distance from the edge to the center of the first hole, and W for the total width. The side view shows the thickness of the plate, labeled t . The cross-sectional view shows the profile of the plate, labeled A . The text "Dimensions in mm" is present at the bottom right.

Type	A	B	øD0	E	F	P0	P1	P2	W	K	t
VLS201610HBX-1	1.9	2.3	1.5+0.1/-0	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	8.0±0.2	1.10	0.25
VLS201612HBX-1	1.9	2.3	1.5+0.1/-0	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	8.0±0.2	1.35	0.25
VLS252010HBX-1	2.3	2.8	1.5+0.1/-0	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	8.0±0.2	1.15	0.25
VLS252012HBX-1	2.3	2.8	1.5+0.1/-0	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	8.0±0.2	1.35	0.25

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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